

Product Summary

$V_{BR(MIN)}$	$I_{PP(MAX)}$	$C_T(TYP)$
6V	1.5A	0.5pF

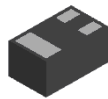
Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in Automotive Infotainment applications.

Applications

- USB Modules
- HDMI Inputs
- Infotainment Consoles

X1-DFN1006-3



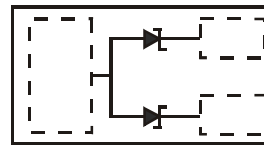
Bottom View

Features

- Low Profile Package (0.53mm Max) and Ultra-Small PCB Footprint Area (1.08 x 0.68mm Max) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air $\pm 15kV$, Contact $\pm 15kV$
- 2 Channels of ESD Protection (Note 6)
- Low Channel Input Capacitance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)



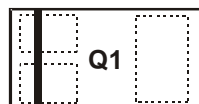
Device Schematic

Ordering Information (Note 5)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D5V0F2U3LPQ-7B	Automotive	Q1	7	8	10,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Please refer to http://www.diodes.com/product_compliance_definitions.html.
 5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
 6. For information on the impact of Diodes Incorporated's USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: <https://www.diodes.com/assets/App-Note-Files/AN77.pdf>.

Marking Information



Top View
Bar Denotes
Cathode Side

Q1 = Product Type Marking Code

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Condition
Peak Pulse Current	I _{PP}	1.5	A	8/20μs (Note 7)
ESD Protection – Contact Discharge	V _{ESD_CONTACT}	±15	kV	Standard IEC61000-4-2
ESD Protection – Air Discharge	V _{ESD_AIR}	±15	kV	Standard IEC61000-4-2

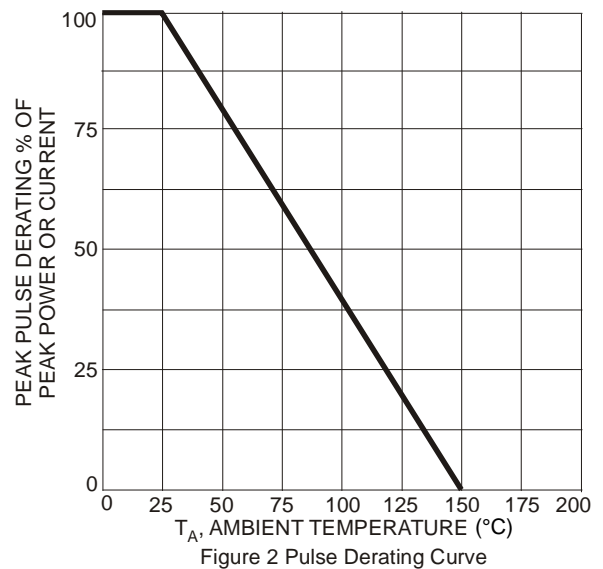
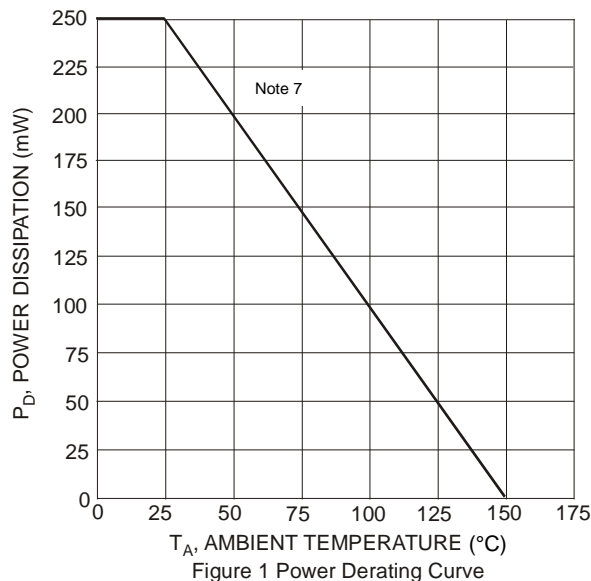
Thermal Characteristics

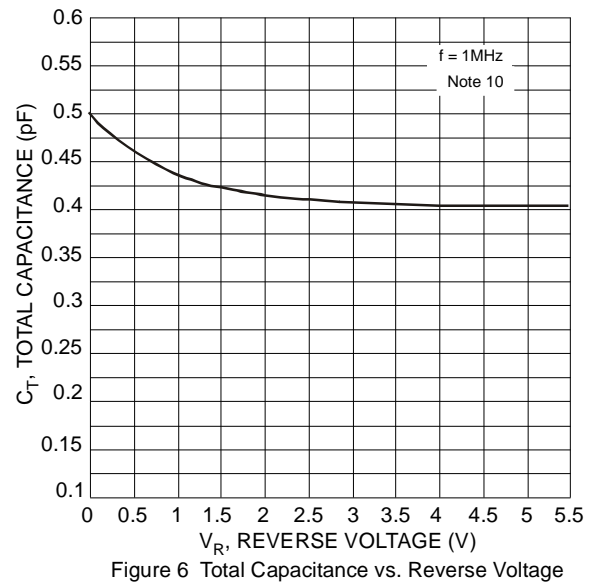
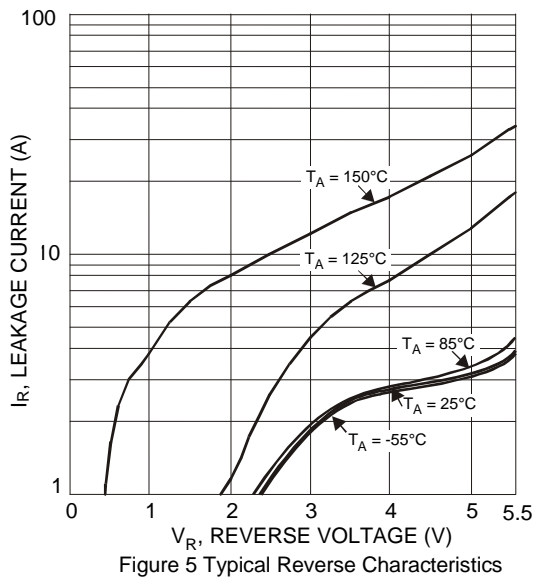
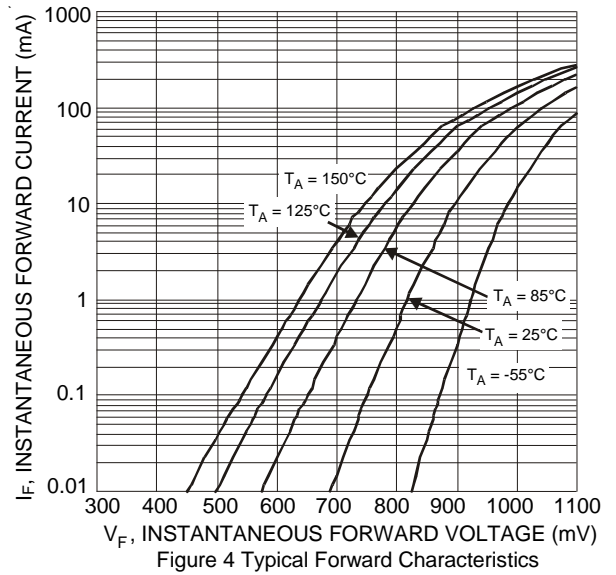
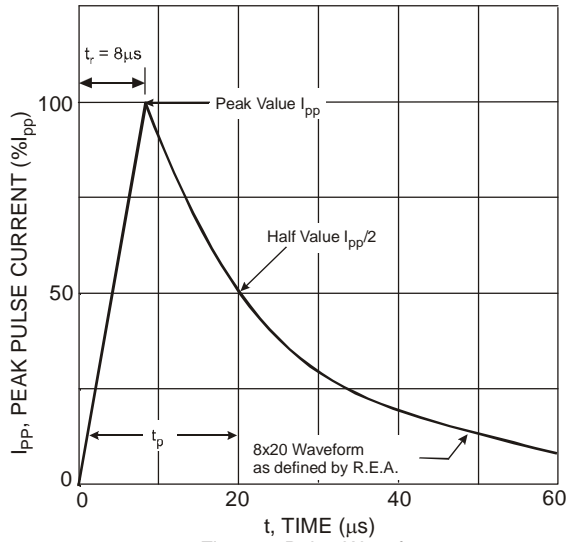
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P _D	300	mW
Thermal Resistance, Junction to Ambient T _A = +25°C	R _{θJA}	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Standoff Voltage	V _{RWM}	—	—	5.5	V	—
Channel Leakage Current (Note 8)	I _R	—	—	100	nA	V _R = 5V, Any I/O to GND
Reverse Breakdown Voltage	V _{BR}	6.0	—	—	V	I _R = 1mA
Clamping Voltage, Positive Transients (Note 9)	V _C	—	10	12	V	I _{PP} = 1A, t _p = 8/20μs
Channel Input Capacitance (Note 10)	C _T	—	0.5	—	pF	V _R = 0V, f = 1MHz, Any I/O to GND
		—	0.4	0.65		V _R = 2.5V, f = 1MHz, Any I/O to GND
Dynamic Resistance	R _{DYN}	—	0.9	—	Ω	I _{PP} = 1A, t _p = 8/20μs

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 - Short duration pulse test used to minimize self-heating effect.
 - Clamping voltage value is based on an 8x20μs peak pulse current (I_{PP}) waveform.
 - Measured from any I/O to GND.

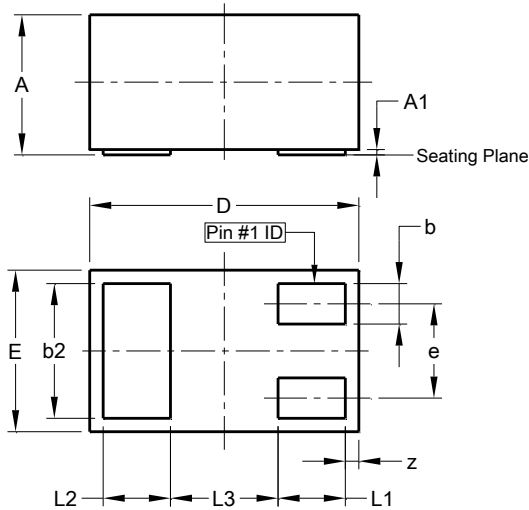




Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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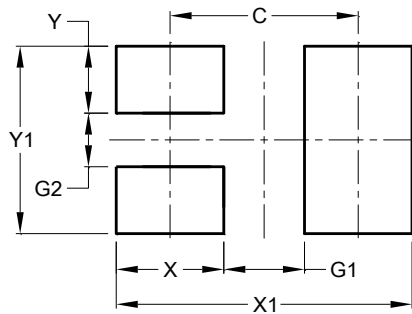


X1-DFN1006-3			
Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0.00	0.05	0.03
b	0.10	0.20	0.15
b2	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
e	-	-	0.35
L1	0.20	0.30	0.25
L2	0.20	0.30	0.25
L3	-	-	0.40
z	0.02	0.08	0.05
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X1-DFN1006-3



Dimensions	Value (in mm)
C	0.70
G1	0.30
G2	0.20
X	0.40
X1	1.10
Y	0.25
Y1	0.70

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